

ATTORNEY DOCKET NO. 82989818

U.S. DEPARTMENT OF COMMERCE  
Patent and Trademark Office

**RECORDATION FORM COVER SHEET  
PATENTS ONLY**

1. Name of conveying party(ies):

Shahar Stein  
Eyal Peleg  
George Trendafilov  
Itzik Shaul

2. Name and address of receiving party(ies):

HEWLETT-PACKARD INDIGO B.V.  
Startbaan 16  
1187 XR Amstelveen  
The Netherlands

Additional name(s) of conveying party(ies) attached?  Yes  No Additional name(s) and address(es) attached?  Yes  No

3. Nature of Conveyance:

Assignment  Merger  Change of Name  Security Agreement  Joint  
 Other

Execution Date(s): 8/1/12; 7/25/12; 8/1/12; 8/2/12

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, execution date of the application is:

A. Patent Application No.(s)

Application No.: 13593711

Date Filed: Aug. 24, 2012

Confirmation No.: 9408

B. Patent No.(s):

Additional numbers attached? NO

5. Name and address of party to whom correspondence concerning document should be mailed:

**Records Manager  
Intellectual Property Administration  
HEWLETT-PACKARD COMPANY  
3404 E. Harmony Road  
Mail Stop 35  
Fort Collins, Colorado 80528**

6. Total number of applications and patents involved: 1

7. Total Fee (37 CFR 3.41): \$40.00

Enclosed

Authorization to be charged to deposit account.

8. Deposit Account Number: 08-2025

9. Statement and signature:

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*

Edouard Garcia  
Name of Person Signing

/Edouard Garcia, Reg. No. 38,461/  
Signature

Aug 24, 2012  
Date

Total number of pages including coversheet, attachments, and documents: 5

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:  
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, V.A. 22313-1450

CH \$40.00 082025 13593711

HEWLETT-PACKARD COMPANY  
Intellectual Property Administrator  
3404 E. Harmony Road  
Mail Stop 35  
Fort Collins, Colorado 80528

PATENT APPLICATION

RECORD ID: 82989818

**ASSIGNMENT OF PATENT APPLICATION**

I/We, the undersigned (each) have agreed and hereby agree to assign to HEWLETT-PACKARD INDIGO B.V., having its registered offices in Amstelveen, The Netherlands, (hereinafter HP-INDIGO), in furtherance of my/our obligations to the Hewlett-Packard Company and its subsidiaries and affiliates, and do hereby assign and transfer to HP-INDIGO, its successors and assigns, the entire right, title and interest, including the right of priority, in, to and under an application for Letters Patent of the United States entitled:

Thickness calibration of an embossing die

Filing Date: August 24, 2012

Application No.: 13593711

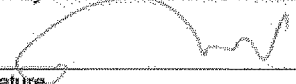
and the invention(s) and improvement(s) set forth therein, and any and all continuations, continuations-in-part (C-I-P's), divisionals, and renewals of and substitutes for said application for said Letters Patent, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefore, and any reissues, or reexaminations, or extensions of said Letters Patent.

I/we additionally authorize HP-INDIGO to file applications in my/our name for Letters Patent in any country, to be held and enjoyed by HP-INDIGO, its successors, assigns, nominees or legal representatives, to the full end of the term or terms for which said Letters Patent respectively may be granted, reissued or extended, as fully and entirely as the same would have been held and enjoyed by me/us had this assignment, and transfer not been made;

AND I/we hereby covenant that I/we have full right to convey the entire interest herein assigned, and that I/we have not executed and will not execute any agreement in conflict herewith, and I/we further covenant and agree that I/we will, each time a request is made, and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title to said invention(s) or improvement(s), said application and said Letters Patent, to HP-INDIGO, its successors, assigns, nominees or legal representatives, and I/we agree to communicate to HP-INDIGO, or to its nominee, all known facts respecting said invention(s) or improvement(s), said application and said Letters Patent, to testify in any legal proceedings, to sign all lawful papers, to execute all disclaimers and divisionals, continuations, C-I-P's, reissue and foreign applications, to make all rightful oaths and declarations, and generally to do everything possible to aid HP-INDIGO, its successors, assigns, nominees and legal representatives to obtain and enforce, for its or their own benefit, proper patent protection for said invention(s) or improvement(s) in any and all countries provided the expenses which may be incurred by me/us in lending such cooperation and assistance are paid by HP-INDIGO;

AND I/we hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any country or countries foreign to the United States whose duty it is to issue patents on applications as aforesaid, to issue to HP-INDIGO, as assignee of the entire right, title and interest, any and all Letters Patent for said invention(s) or improvement(s), including any and all Letters Patent of the United States which may be issued and granted on or as a result of the application aforesaid, in accordance with the terms of this assignment.

I/we further authorize and direct the attorneys of record to insert the serial number and filing date of said application now identified by the Record ID and title set forth above as soon as the same shall have been made known to them by the United States Patent and Trademark Office.

  
\_\_\_\_\_  
Inventor's Signature

Shahar Stein  
\_\_\_\_\_  
Inventor's Typed Name

1/8/2012  
\_\_\_\_\_  
Date Assignment Signed

1/8/2012  
\_\_\_\_\_  
Date Application Signed

\_\_\_\_\_  
Inventor's Signature

Eyal Peleg  
\_\_\_\_\_  
Inventor's Typed Name

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Intellectual Property Administrator  
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Fort Collins, Colorado 80528

PATENT APPLICATION

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**ASSIGNMENT OF PATENT APPLICATION**

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**Thickness calibration of an embossing die**

**Filing Date:** August 24, 2012 **Application No.:** 13593711

and the invention(s) and improvement(s) set forth therein, and any and all continuations, continuations-in-part (C-I-P's), divisionals, and renewals of and substitutes for said application for said Letters Patent, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefore; and any reissues, or reexaminations, or extensions of said Letters Patent.

I/we additionally authorize HP-INDIGO to file applications in my/our name for Letters Patent in any country, to be held and enjoyed by HP-INDIGO, its successors, assigns, nominees or legal representatives, to the full end of the term or terms for which said Letters Patent respectively may be granted, reissued or extended, as fully and entirely as the same would have been held and enjoyed by me/us had this assignment, and transfer not been made;

AND I/we hereby covenant that I/we have full right to convey the entire interest herein assigned, and that I/we have not executed and will not execute any agreement in conflict herewith, and I/we further covenant and agree that I/we will, each time a request is made, and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title to said invention(s) or improvement(s), said application and said Letters Patent, to HP-INDIGO, its successors, assigns, nominees or legal representatives, and I/we agree to communicate to HP-INDIGO, or to its nominee, all known facts respecting said invention(s) or improvement(s), said application and said Letters Patent, to testify in any legal proceedings, to sign all lawful papers, to execute all disclaimers and divisionals, continuations, C-I-P's, reissue and foreign applications, to make all rightful oaths and declarations, and generally to do everything possible to aid HP-INDIGO, its successors, assigns, nominees and legal representatives to obtain and enforce, for its or their own benefit, proper patent protection for said invention(s) or improvement(s) in any and all countries provided the expenses which may be incurred by me/us in lending such cooperation and assistance are paid by HP-INDIGO;

AND I/we hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any country or countries foreign to the United States whose duty it is to issue patents on applications as aforesaid, to issue to HP-INDIGO, as assignee of the entire right, title and interest, any and all Letters Patent for said invention(s) or improvement(s), including any and all Letters Patent of the United States which may be issued and granted on or as a result of the application aforesaid, in accordance with the terms of this assignment.

I/we further authorize and direct the attorneys of record to insert the serial number and filing date of said application now identified by the Record ID and title set forth above as soon as the same shall have been made known to them by the United States Patent and Trademark Office.

Inventor's Signature

Date Assignment Signed

Shahar Stein  
Inventor's Typed Name

Date Application Signed

  
Inventor's Signature

25/July/2012  
Date Assignment Signed

Eyal Peleg  
Inventor's Typed Name

25/July/2012  
Date Application Signed

HEWLETT-PACKARD COMPANY  
Intellectual Property Administrator  
3404 E. Harmony Road  
Mail Stop 35  
Fort Collins, Colorado 80528

PATENT APPLICATION

RECORD ID: 82989818

ASSIGNMENT OF PATENT APPLICATION (cont.)

*George Trendafilov*  
Inventor's Signature 1.08.1012  
Date Assignment Signed

George Trendafilov  
Inventor's Typed Name 1.08.1012  
Date Application Signed

*Izic Shaul*  
Inventor's Signature 2/08/2012  
Date Assignment Signed

Izic Shaul  
Inventor's Typed Name 2/08/2012  
Date Application Signed

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